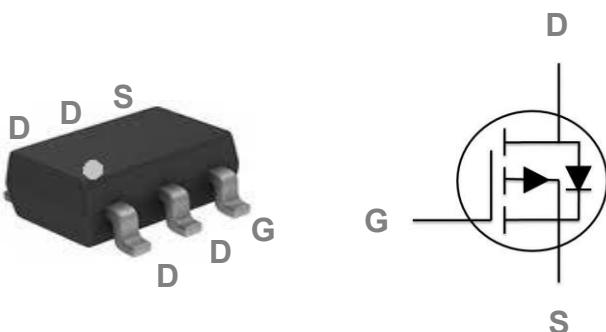


### General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### SOT23-6L Pin Configuration



BVDSS	RDSON	ID
-20V	28mΩ	-4.8A

### Features

- -20V, -4.8A,  $RDS(ON) = 28m\Omega @ VGS = -4.5V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

### Applications

- Notebook
- Load Switch
- Networking

### Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D$	Drain Current – Continuous ( $T_A=25^\circ C$ )	-4.8	A
	Drain Current – Continuous ( $T_A=70^\circ C$ )	-3.8	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	-19.2	A
$P_D$	Power Dissipation ( $T_A=25^\circ C$ )	1	W
	Power Dissipation – Derate above $25^\circ C$	0.008	$W/^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	125	$^\circ C/W$

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=-250\mu\text{A}$	-20	---	---	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=-20\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	-1	$\mu\text{A}$
		$V_{\text{DS}}=-16\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	-10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 12\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

**On Characteristics**

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-2\text{A}$	---	23	28	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}$ , $I_{\text{D}}=-1.5\text{A}$	---	32	40	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=-250\mu\text{A}$	-0.5	-0.8	-1.1	V
			---	2	---	
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient					$\text{mV}/\text{C}$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$ , $I_{\text{S}}=-1\text{A}$	---	8.4	---	S

**Dynamic and switching Characteristics**

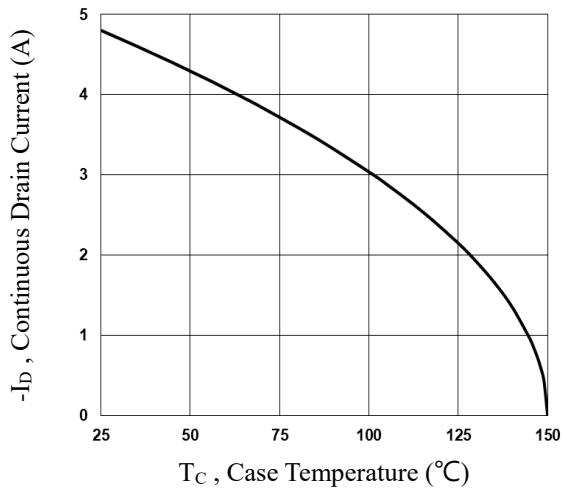
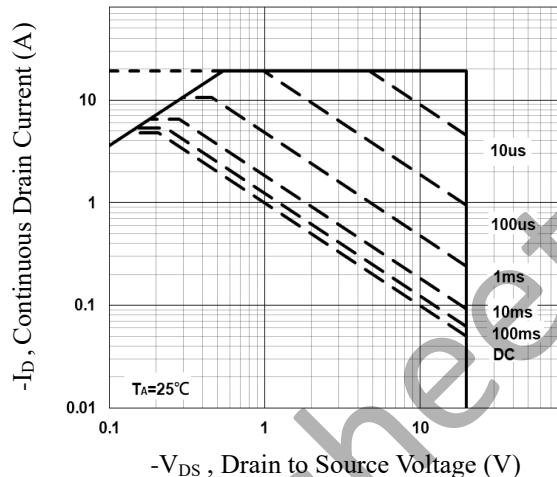
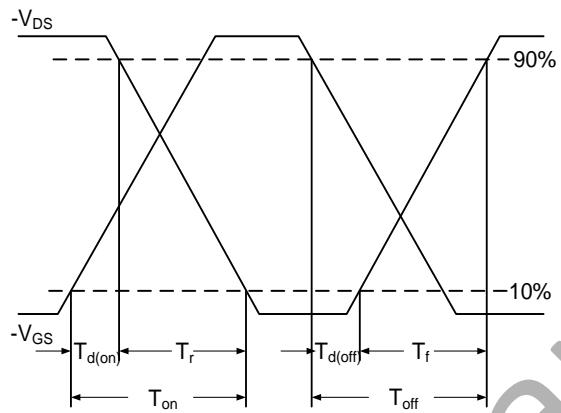
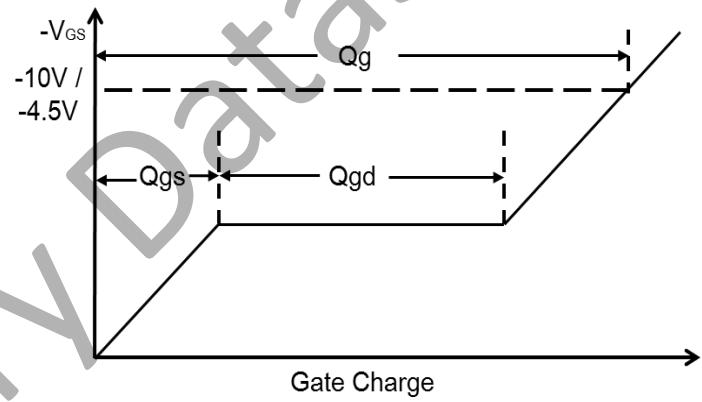
$Q_g$	Total Gate Charge <sup>2,3</sup>	$V_{\text{DS}}=-10\text{V}$ , $V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-2\text{A}$	---	---	---	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>2,3</sup>		---	---	---	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>2,3</sup>		---	---	---	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>2,3</sup>	$V_{\text{DD}}=-10\text{V}$ , $V_{\text{GS}}=-4.5\text{V}$ , $R_{\text{G}}=25\Omega$ $I_{\text{D}}=-1\text{A}$	---	---	---	nS
$T_r$	Rise Time <sup>2,3</sup>		---	---	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>2,3</sup>		---	---	---	
$T_f$	Fall Time <sup>2,3</sup>		---	---	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-10\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	---	---	pF
$C_{\text{oss}}$	Output Capacitance		---	---	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	---	---	

**Drain-Source Diode Characteristics and Maximum Ratings**

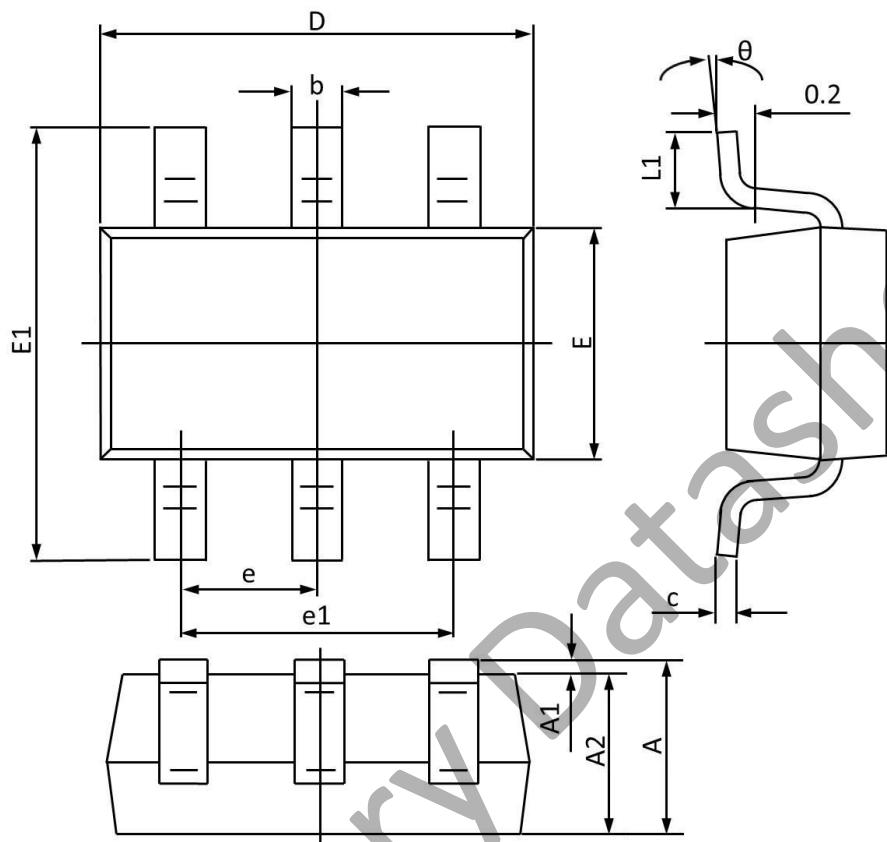
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	-4.8	A
			---	---	-9.6	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=-1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	-1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs. Tc**

**Fig.2 Maximum Safe Operation**

**Fig.3 Switching Time Waveform**

**Fig.4 Gate Charge Waveform**

## SOT23-6L PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.450	-	0.057	-
A1	0.100	0.000	0.004	0.000
A2	1.300	1.050	0.051	0.041
b	0.500	0.300	0.020	0.012
c	0.200	0.100	0.008	0.004
D	3.100	2.700	0.122	0.106
E	1.800	1.400	0.071	0.055
E1	3.000	2.600	0.118	0.102
e	0.95BSC		0.037BSC	
e1	2.000	1.800	0.079	0.071
L1	0.600	0.300	0.024	0.012
$\theta$	10°	0°	10°	0°